

HTP Series

Descriptions

This product is suitable for various kinds of electronic devices' circuit over current protection. Widely used in industrial of Lighting, Power supply and Adapter applications, etc.



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Product Characteristics

- Lead Pull Strength: 5N for 10±1 Seconds.
- Lead Thrust Strength: 2N for 10±1 Seconds.
- Solder Ability: Wave: 260°C,≤3s;
 Soldering Iron: 350±10°C,≤3s.
- Soldering Heat Resistance: Wave : 260°C,10s;
 Soldering Iron: 350°C,5s.

Material Details

Part Name	Material	
Сар	Nickel Plated Brass	
Body	Non-Transparent Ceramic Tube	
Fuse Element	Alloy	
Lead Wire	Tin Plated Copper	



HTP Series

Electrical Characteristics			
Part Number	Ampere Rating (A)	Voltage Rating Vac(V)	Breaking Capacity
HTP1600A	6	250V	50A@250VAC
HTP1630A	6.3	250V	50A@250VAC

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Electrical	Characteristics
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HTP1700A

HTP1800A

HTP2100A

HTP2120A

- Test Condition: All electrical test is to be conducted with the ambient air at a temperature of 25±5°C.
- Load Capacity: When the fuse loads through 100% of rated current, should blow within 4 hours.
- Interrupting Rating: Breaking Capacity: 50A at 250V AC.
- Rising Temperature Test:

When the 100% times of Ampere Rating passes the fuse, after reaching thermal balance , the temperature on the fuse surface rising shall not be higher than 75°C. Note: Rising temperature = the Surface temperature - Ambient temperature.

250V

250V

250V

250V

50A@250VAC

50A@250VAC

50A@250VAC

50A@250VAC

• Operating Characteristics:

% of Ampere Rating(In)	Blowing Time
100% * In	4 hours Min
200% * In	60 sec Max



I²T Melting Integral(A².S)

58

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68

72





HTP Series

Environmental Characteristics

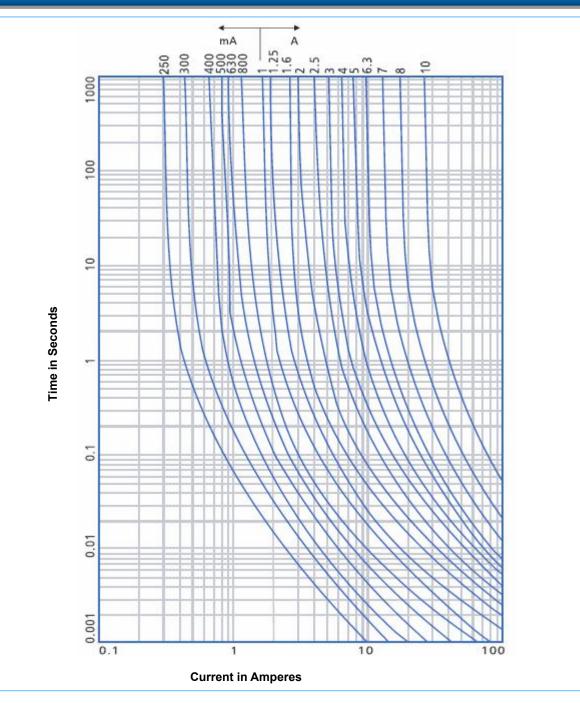
- ♦ Operating Temperature: -55°C~+125°C.
- ♦ Stock Condition: Humidity:Relative humidity ≤ 75% store 3 years in average.
- ♦ When choosing the fuse's specification, if the operating environmental temperature beyond the scope from 20~30°C, engineer should consider the environmental temperature's affection to fuses. Please refer: Temperature Rerating Curve:

140 T I Ť. 120 I PERCENT OF RATING 100 1 1 80 1 1 60 T 25°C 40 1 1 20 1 -60°C -40°C -20°C 0°C 20°C 40°C 60°C 80°C 100°C 120°C -76°F -40°F -4°F 32°F 68°F 104°F 140°F 176°F 212°F 248°F **AMBIENT TEMPERATURE**



HTP Series

Average Time Current Curves









HTP Series

Recommended Soldering Parameters

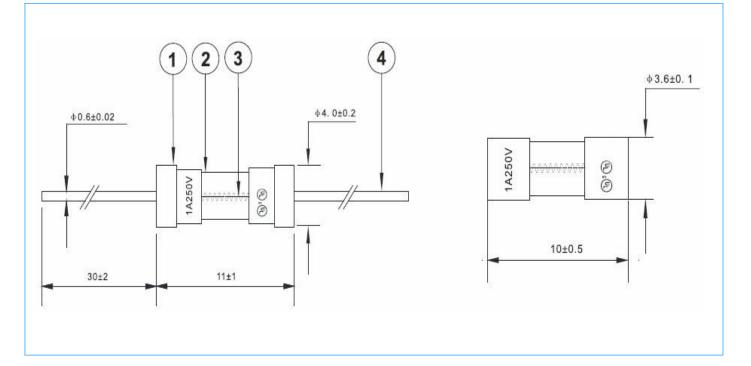
Wave Parameters:

Solder Pot Temperature: 260°C Max; Solder Dwell Time: 2~5s

• Hand-Solder Parameters:

Solder Iron Temperature: 350 ± 5 °C; Heating Time: 5s Max..

Dimensions and Structure (Unit: mm)

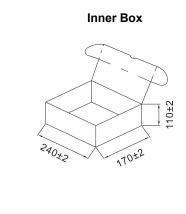


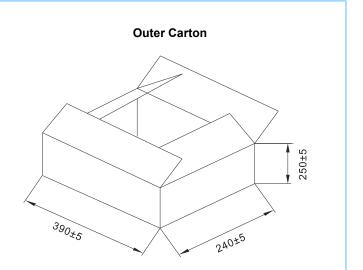
Packing Quantity			
Series	poly bag	inner box	outer carton
HTP Series	500 pcs	10 poly bags	4 inner boxes



HTP Series

Packing Size (Unit: mm)





Туре	L	w	н
Inner Box	240±2	170±2	110±2
Туре	L	w	н
Outer Carton	390±5	240±5	250±5

